HF

PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR SAFETY RECOGNIZED

TYPE: AH SERIES （X1:500V~/Y1:500V~/1500Vdc）

CUSTOMER: _____

DOC. NO.: POE-D25-00-E-07

符合 RoHS&HF 及其他環保要求；金屬電鍍層不含六價鉻
RoHS &HF& Requirements of Environmental; Prohibit containing Cr+6 in the plating with metal

APPROVED BY CUSTOMER

VENDOR：

☐ **WALSIN TECHNOLOGY CORPORATION**
566-1, KAO SHI ROAD,YANG-MEI
TAO-YUAN, TAIWAN

☐ **PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.**
NO.277,HONG MING ROAD,EASTERN SECTION,
HUANGPU DISTRICT ,GUANG ZHOU,CHINA

☐ **DONGGUAN WALSIN TECHNOLOGY ELECTRONICS CO., LTD.**
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MANUFACTURE SITE：

☑ **PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.**
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Record of change

Date	Version	Description	page
2019/2/25	00	1. First edition.	All
2019/12/29	01	1. Review the Available lead code of Lead Configuration 2. Add “8.3 Label samples ”	5 14
2021/9/9	02	1. Delete Walsin & POE logo.	1
2022/4/21	03	1. Add Applied voltage in 9.3 Test condition for withstanding voltage. 2. Add 10.2 List of substances that affect the insulation strength of coating	16-17 19
2023/5/26	04	1. Revised recognized No. of SEMKO and FIMKO.	10
2023/9/25	05	1. Review the bulk packing quantity of the code of 14th to15th ≧12	15
2024/7/10	06	1. Revised recognized No. of SEV, SEMKO and FIMKO.	10
2025/7/6	07	1. Revised recognized No. of SEV 2. Review the Drawing of Internal Structure and material list	10 21

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華新科技股份有限公司
PSA
PASSIVE SYSTEM ALLIANCE
Walsin Technology Corporation
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1. Part number for SAP system:

(Ex.)	YU	5	AH	472	M	13	0	D	3E	A	0	H
	(1)	(2)-1	(2)-2	(3)	(4)	(5)	(6)	(7)	(8)	(9)	(10)	(11)

(1) Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
SL	SL	-1000~+350PPM/℃ (+20℃~+85℃)
YP	B (Y5P)	±10%
YU	E (Y5U)	-55% to +20%
YV	F (Y5V)	-80% ~ +30%

(2)-1 Rated voltage(identified by 1-figure code)： 5=X1:500V~/Y1:500V~/1500Vdc

(2)-2 Type(identified by 2-figure code)：AH

(3) Capacitance (identified by 3-figure code):EX.221=220pF

(4) Capacitance tolerance (identified by code): J:±5%,K:±10%,M:±20%

(5) Nominal body diameter dimension (Refer to “3. Part numbering/T.C/Capacitance/ Tolerance/Diameter”)

(6) Internal code: 0--Normal, other code--Special control

(7) Lead Style：Refer to “2. Mechanical”.

(8) Packing mode and lead length (identified by 2-figure code): Refer to “2. Mechanical” & “4.Taping Format”

Taping Code	Description
AM	Ammo box and product pitch：25.4 mm
AS	Ammo box and product pitch：15.0 mm (Only for the SAP part number 11-12 digits ≦ 10)

Bulk Code	**Description**
03	Lead length ： 3.0mm
3E	Lead length ： 3.5mm
04	Lead length ： 4.0mm
4E	Lead length ： 4.5mm
20	Lead length ： 20mm

(9) Length tolerance

Code	**Description**	
A	±0.5 mm (only for kink lead type)	Short lead
B	±1.0 mm	Short lead
C	Min.	Long lead
D	Taping special purpose	Taping

(10) Pitch

Code	**Description**
0	10±1 mm
A	10±0.5 mm
C	12.5±0.8 mm

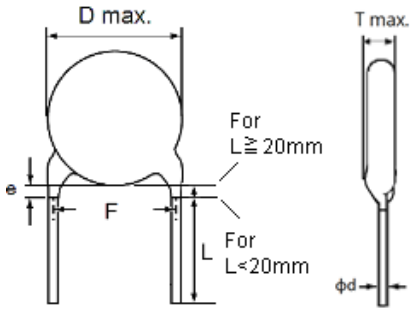
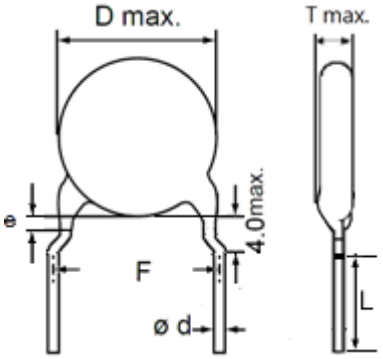
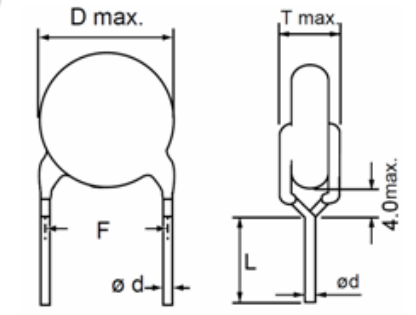
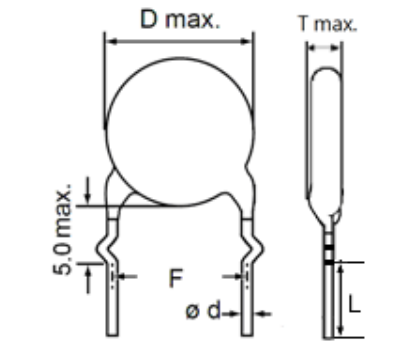
(11) Epoxy Resin Code

Code	**Description**
H	Halogen and Pb free, epoxy resin.

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2. Mechanical: Encapsulation：Epoxy resin, flammability UL94 V-0

Available lead code (unit: mm):

Lead type	SAP P/N (13-17)digits	Pitch (F)	Lead Length (L)	Packing	Lead Configuration
Lead style：L or B Type L or B Straight lead	L03B0	10 ± 1.0	3.0 ± 1.0	Bulk	
	L4EB0	10 ± 1.0	4.5 ± 1.0		
	L05B0	10 ± 1.0	5.0 ± 1.0		
	L03BC	12.5 ± 0.8	3.0 ± 1.0		
	L3EAC	12.5 ± 0.8	3.5 ± 0.5		
	L4EBC	12.5 ± 0.8	4.5 ± 1.0		
	L20C0	10 ± 1.0	20 min.		
	L20CC	12.5 ± 0.8	20 min.		
	BASD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	BAMD0	10 ± 1.0			
	BAMDC	12.5 ± 0.8			
Lead style：G Type G Straight lead	G03B0	10 ± 1.0	3.0 ± 1.0	Bulk	
	G4EB0	10 ± 1.0	4.5 ± 1.0		
	G05B0	10 ± 1.0	5.0 ± 1.0		
	GASD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	GAMD0	10 ± 1.0			
Lead style：D Type D Vertical kink lead	D03A0	10 ± 1.0	3.0 ± 0.5	Bulk	
	D3EA0	10 ± 1.0	3.5 ± 0.5		
	D04A0	10 ± 1.0	4.0 ± 0.5		
	D03AC	12.5 ± 0.8	3.0 ± 0.5		
	D3EAC	12.5 ± 0.8	3.5 ± 0.5		
	D04AC	12.5 ± 0.8	4.0 ± 0.5		
	D20C0	10 ± 1.0	20 min.		
	DASD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	
	DAMD0	10 ± 1.0			
	DAMDC	12.5 ± 0.8			
Lead style：X Type X Outside kink lead	X03A0	10 ± 1.0	3.0 ± 0.5	Bulk	
	X3EA0	10 ± 1.0	3.5 ± 0.5		
	X04A0	10 ± 1.0	4.0 ± 0.5		
	X03AC	12.5 ± 0.8	3.0 ± 0.5		
	X3EAC	12.5 ± 0.8	3.5 ± 0.5		
	X04AC	12.5 ± 0.8	4.0 ± 0.5		
	XAMD0	10 ± 1.0	Refer to “4. Taping format”	Tap. Ammo	

***** Lead diameter Φd: 0.55+0.1/-0.05mm

*e (Coating **extension** on leads): 3.0mm Max for straight lead style, not exceed the kink for kink lead.

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3. Part numbering/T.C/Capacitance/ Tolerance/Diameter：

SAP P/N	T.C.	Capacitance(pF)	Tolerance	Dimension (unit:mm)			
				D(max.)	T(max.)	F	Φd
SL5AH***J060*	SL*	10,12,15,18,20,22,24, 27,30,33, 36, 39(pF)	±5%	7.0	5.0	10±1	0.55+0.1/-0.05
SL5AH***J070*		47,50,51, 56,62(pF)		8.0			
SL5AH***J080*		68,75(pF)		9.0			
SL5AH***J090*		82,100(pF)		10.0			
YP5AH101K060*	Y5P	100 pF	±10%	7.0			
YP5AH151K060*		150 pF		7.0			
YP5AH221K060*		220 pF		7.0			
YP5AH331K060*		330 pF		7.0			
YP5AH471K070*		470 pF		8.0			
YP5AH561K080*		560 pF		9.0			
YP5AH681K080*		680 pF		9.0			
YP5AH102K100*		1000 pF		11.0			
YU5AH471M060*	Y5U	470 pF	±20%	7.0	5.0	10±1	0.55+0.1/-0.05
YU5AH561M060*		560 pF		7.0			
YU5AH681M060*		680 pF		7.0			
YU5AH102M070*		1000 pF		8.0			
YU5AH152M080*		1500 pF		9.0			
YU5AH222M090*		2200 pF		10.0			
YU5AH332M110*		3300 pF		12.0			
YU5AH392M120*		3900 pF		13.0			
YU5AH472M130*		4700 pF		14.0			
YV5AH102M060*	Y5V	1000pF		7.0	5.5		
YV5AH152M070*		1500pF		8.0			
YV5AH222M080*		2200pF		9.0			
YV5AH332M100*		3300pF		11.0			
YV5AH472M110*		4700pF		12.0			

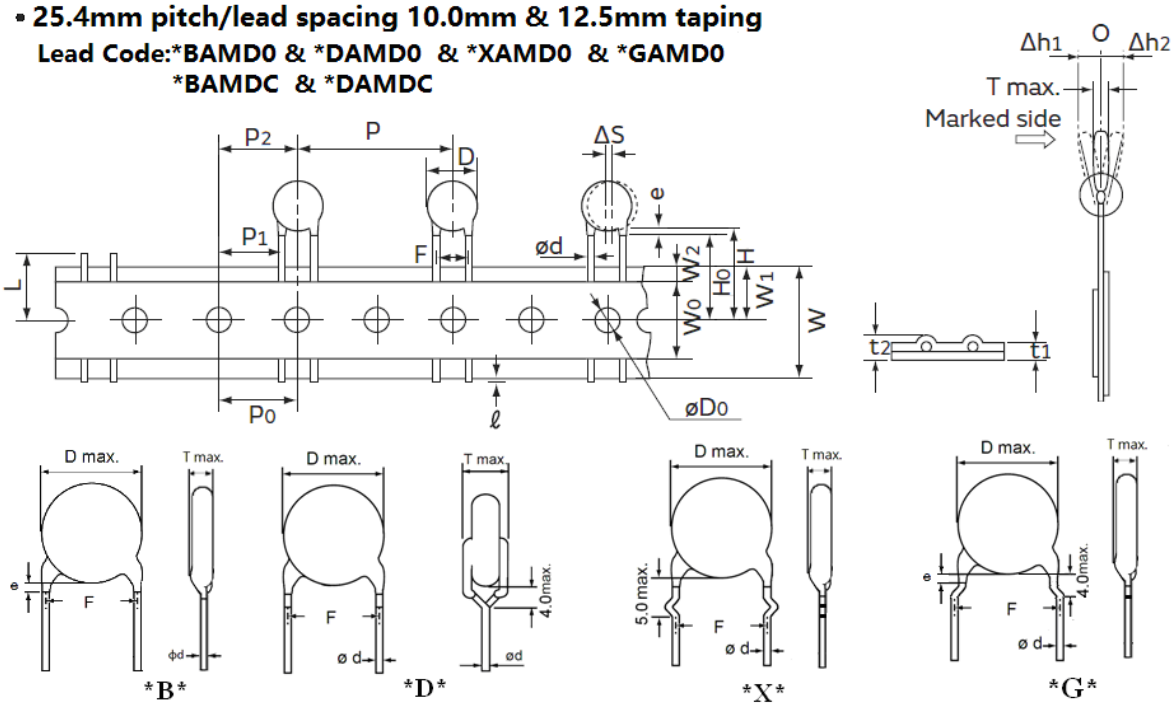
- The minimum thickness of coating (reinforced insulation) is 0.4mm.

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4. Taping Format:

- **25.4mm pitch/lead spacing 10.0mm & 12.5mm taping**

Lead Code:*BAMD0 & *DAMD0 & *XAMD0 & *GAMD0
***BAMDC & *DAMDC**

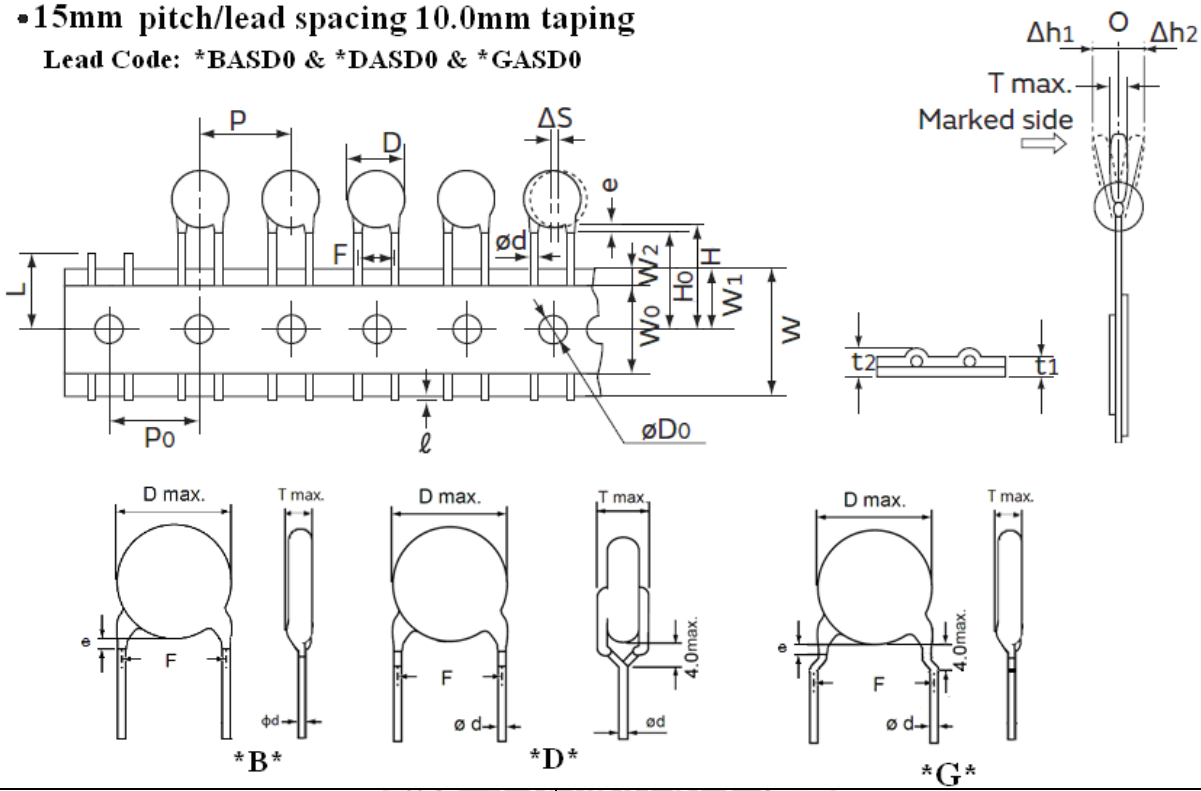


POE Part Number		*BAMD0 / *DAMD0 *XAMD0 / *GAMD0	*BAMDC / *DAMDC
Item	Symbol	Dimensions(mm)	Dimensions(mm)
Pitch of component	P	25.4 ± 2	25.4 ± 2
Pitch of sprocket	P0	12.7 ± 0.3	12.7 ± 0.3
Lead spacing	F	10.0 ± 1.0	12.5 ± 0.8
Length from hole center to component center	P2	12.7 ± 1.5	12.7 ± 1.5
Length from hole center to lead	P1	7.7 ± 1.5	6.2 ± 1.5
Body diameter	D	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"	
Deviation along tape, left or right	Δ S	0 ± 2.0	
Carrier tape width	W	18.0 +1/ -0.5	
Position of sprocket hole	W1	9.0 ± 0.5	
Lead distance between the kink and center of sprocket hole	H0	18.0 +2.0/-0 (For: *DAMD0 & *XAMD0&*GAMD0)	18.0 +2.0/-0 (For: *DAMDC)
Lead distance between the bottom of body and the center of sprocket hole	H	20.0+1.5/-1.0 (For: *BAMD0)	20.0+1.5/-1.0 (For: *BAMDC)
Length from the terminal of the lead wire to the edge of carrier tape	ℓ	+0.5 to -1.0 (Or the end of lead wire may be inside the hole-down tape.)	
Diameter of sprocket hole	D0	4.0 ± 0.2	
Lead diameter	φd	0.55+0.1/-0.05	
Total tape thickness	t1	0.6 ± 0.3	
Total thickness, tape and lead wire	t2	1.5 max.	
Deviation across tape	Δ h1/Δ h2	2.0 max.	
Portion to cut in case of defect	L	11.0 max.	
Hole-down tape width	W0	8.0 min	
Hole-down tape distortion	W2	1.5 ± 1.5	
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.	
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"	

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•15mm pitch/lead spacing 10.0mm taping

Lead Code: *BASD0 & *DASD0 & *GASD0



POE Part Number		*BASD0/*DASD0/*GASD0
Item	Symbol	Dimensions(mm)
Pitch of component	P	15.0±1
Pitch of sprocket	P0	15.0±0.3
Lead spacing	F	10.0±1.0
Body diameter	D	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"
Deviation along tape, left or right	Δ S	0 ± 2.0
Carrier tape width	W	18.0 +1/ -0.5
Position of sprocket hole	W1	9.0 ± 0.5
Lead distance between the kink and center of sprocket hole	H0	18.0 +2.0/-0 (For: *DASD0 & *GASD0)
Lead distance between the bottom of body and the center of sprocket hole	H	20.0+1.5/-1.0 (For: *BASD0)
Length from the terminal of the lead wire to the edge of carrier tape	ℓ	+0.5 to -1.0 (or the end of lead wire may be inside the hole-down tape.)
Diameter of sprocket hole	D0	4.0 ± 0.2
Lead diameter	φd	0.55+0.1/-0.05
Total tape thickness	t1	0.6 ± 0.3
Total thickness, tape and lead wire	t2	1.5 max.
Deviation across tape	Δ h1/Δ h2	2.0 max.
Portion to cut in case of defect	L	11.0 max.
Hole-down tape width	W0	8.0 min
Hole-down tape distortion	W2	1.5 ± 1.5
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink lead.
Body thickness	T	See the "3. Part numbering/T.C/Capacitance/ Tolerance/Diameter"

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5. Marking:

1.Type Designation	5AH
2.Nominal Capacitance	Identified by 3-Figure Code. Ex. 47pF→"47"，470pF→"471"
3.Capacitance Tolerance	J:±5%,K:±10%,M:±20%
4.Company Name Code(Trade mark)	UK
5.Class code	X1: 500V~ / Y1: 500V~ /1500Vdc
6. Products ID	Abbreviation ex.: Manufacture year: ← 5 C 6 1234 → Last 4 digits of lot no. → Individual specification code 5:2025 6:2026 7:2027 ⋮ Manufactory: C:Pan overseas (Guangzhou) Manufacture month: 1:January 2:Feruary ⋮ 9:September O:October N:November D:December
Marking ex.	
Two sides marking	
	
* Marking by the laser. * " • "：Individual specification code, it is added under the lot no.	

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6. Scope:

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

6.1Applicable safety standard

This specification applies to the UL/CUL, ENEC, FIMKO, approved ceramic capacitors disc type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC384-14. "UL,ENEC recognized capacitor for across-the-line, line-by-pass" and antenna-isolation.

6.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Recognized No.	Rated Volt.
UL / CUL	UL 60384-14 (2nd ed.)	E146544	X1:500Vac Y1:500Vac 1500Vdc
ENEC (DEMKO)	EN 60384-14	ENEC-05460	
VDE (ENEC)	DIN IEC EN 60384-14 (VDE 0565-1-1):2024-10; EN IEC 60384-14:2023-03 IEC 60384-14:2023	40001804	
FIMKO	EN IEC 60384-14:2023	FI_42172	
SEV	EN IEC 60384-14:2023	25.0606	
DEMKO	EN IEC 60384-14:2023	D-07609	
SEMKO	EN IEC 60384-14:2023	SE-S-2500705	
NEMKO	EN IEC 60384-14:2023	PRJ0086795	
CQC	IEC60384-14:2013+AMDI:2016	CQC03001003673	

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7. Specification and test method:

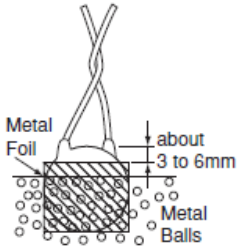
7.1 Operating Temperature Range: -40 to +125℃

7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature 15~35℃, relative humidity 45~75% and atmospheric pressure 860~1060hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature 20±2℃or25 ± 2℃, relative humidity 60~70% and atmospheric pressure 860~1060hpa.)

7.3 Performance:

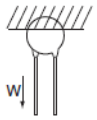
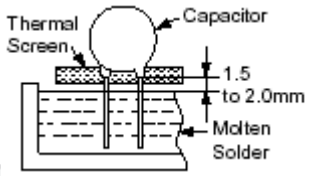
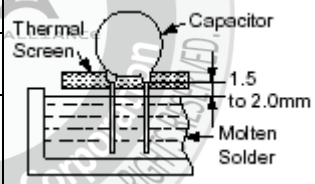
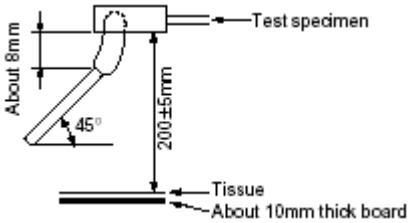
<table>
<tr><th>No</th><th colspan="2">Items</th><th>Specification</th><th>Testing method</th></tr>
<tr><td>1</td><td colspan="2">Appearance and dimensions</td><td>No marked defect on appearance form and dimensions.
Please refer to [Part number list].</td><td>The capacitor should be inspected by naked eyes for visible evidence of defect.
Dimensions should be measured with slide calipers.</td></tr>
<tr><td>2</td><td colspan="2">Marking</td><td>To be easily legible.</td><td>The capacitor should be inspected by naked eyes.</td></tr>
<tr><td rowspan="2">3</td><td>Dielectric Strength</td><td>Between lead wires</td><td>No failure.</td><td>The capacitor should not be damaged when AC4000V(r.m.s.) <50/60Hz> is applied between the lead wires for 60 s.
(Charge/Discharge current ≦50mA.)
Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.</td></tr>
<tr><td></td><td>Body Insulation</td><td>No failure.</td><td>First, the terminals of the capacitor should be connected together.
Then, a metal foil should be closely wrapped around the body of the capacitor
to the distance of about 3 to 6mm from each terminal. Then, the capacitor should be inserted into a container filled with metal balls of about 1mm diameter.
Finally, AC4000V (r.m.s.)<50/60Hz> is applied for 60 s between the capacitor lead wires and metal balls.
(Charge/Discharge current ≦ 50mA.)


Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements..</td></tr>
<tr><td>4</td><td>Insulation Resistance</td><td>Between terminals</td><td>10000MΩ or more.</td><td>The insulation resistance should be measured with DC500±50V within 60±5 s of charging.
The voltage should be applied to the capacitor through a resistor of 1MΩ
Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.</td></tr>
<tr><td>5</td><td colspan="2">Capacitance</td><td>Within specified tolerance</td><td>Y5P&Y5U&Y5V: The capacitance shall be measured at 20±2℃ with 1kHz±20% and 1.0Vrms.
SL: The capacitance shall be measured at 25℃ with 1MHz±20% and 1.0Vrms
Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.</td></tr>
<tr><td>6</td><td colspan="2">Dissipation Factor(D.F.)
Q</td><td><table><tr><th>Char.</th><th>Specifications</th></tr><tr><td>B(Y5P)
E(Y5U)</td><td>2.5% max.</td></tr><tr><td>F(Y5V)</td><td>5.0% max.</td></tr><tr><td>SL</td><td>Q≧400+20C*₂(C<30pF)
≧1000 (C≧30pF)</td></tr></table></td><td></td></tr>
<tr><td>7</td><td colspan="2">Temperature Characteristic</td><td><table><tr><th>Char.</th><th>Capacitance Change</th></tr><tr><td>B(Y5P)</td><td>Within ± 10%</td></tr><tr><td>E(Y5U)</td><td>Within +20/-55%</td></tr><tr><td>F(Y5V)</td><td>Within -80~+30%</td></tr></table>(Temp. range: -25 to +85°C)
<table><tr><th>Char.</th><th>Capacitance Change</th></tr><tr><td>SL</td><td>-1000~+350 ppm/℃</td></tr></table>(Temp. range: +20 to +85°C)</td><td>The capacitance measurement shall be made at each step specified in Table
<table><tr><th>Step</th><th>1</th><th>2</th><th>3</th><th>4</th><th>5</th></tr><tr><td>Temp.(℃)</td><td>+20±2</td><td>-25±2</td><td>+20±2</td><td>+85±2</td><td>+20±2</td></tr></table>Pre-treatment:
Capacitor shall be stored at 125±2℃ for 1hour, then placed at ※1room condition for 24±2hours before measurements.</td></tr>
<tr><td>8</td><td colspan="2">Solderability of Leads</td><td>Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.</td><td>The lead wire of capacitor should be dipped into molten solder for 5 ± 0.5 sec.
The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires.
Temp. of solder：Lead Free Solder (Sn-3Ag-0.5Cu)
245±5℃</td></tr>
</table>

※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

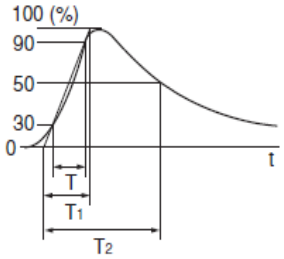
※ "C" expresses nominal capacitance value (pF).

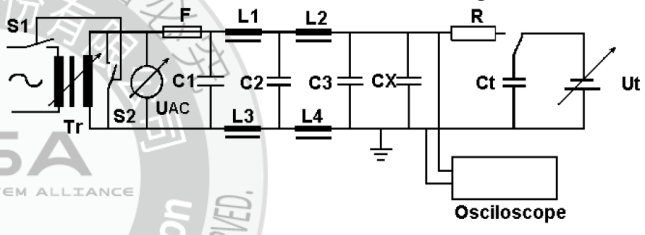
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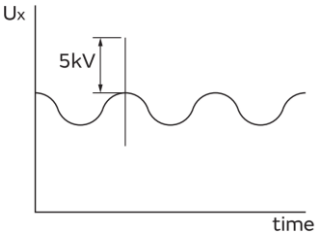
No	Items		Specification	Testing method
9	Robustness of Terminations	Tensile	Lead wire shall not cut off capacitor shall not be broken.	As shown in the figure at right, fix the body of the capacitor and apply a tensile weight gradually to each lead wire in the radial direction of the capacitor up to 10N and keep it for 10±1 sec. 
		Bending	Lead wire shall not cut off. Capacitor shall not be broken.	With the termination in its normal position, the specimen is held by its body in such a manner that the axis of the termination is vertical; a mass applying a force of 5N is then suspended from the end of the termination. The body of the specimen is then inclined, within a period of 2 to 3sec, through an angle of approximately 90° in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One bend immediately followed by a second bend in the opposite direction.
10	Soldering Effect (Non-Preheat)	Appearance	No marked defect.	As shown in figure, the lead wires should be immersed in solder of 350 ± 10 ℃ or 260 ± 5 ℃ up to 1.5 to 2.0 mm from the root of terminal for 3.5 ± 0.5 sec (10 ± 1 sec. for 260 ± 5 ℃).  Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.
		I.R.	1000 MΩ min.	
		Dielectric Strength	Per item 3	
		Capacitance Change	B(Y5P),E(Y5U),F (Y5V)：Within ±10% SL：Within±2.5% or ±0.25pF, Whichever is large.	
11	Soldering Effect (On-Preheat)	Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5 ℃ for 60 +0/-5 sec. Then, as in figure, the lead wires should be immersed solder of 260+0/-5 ℃ up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 sec.  Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.
		I.R.	1000 MΩ min.	
		Dielectric Strength	Per item 3	
		Capacitance Change	B(Y5P),E(Y5U),F (Y5V)：Within ±10% SL：Within±2.5% or ±0.25pF, Whichever is large.	
12	Passive Flammability		The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.	The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec. Length of flame : 12±1mm Gas burner: Length 35mm min. Inside Dia. : 0.5±0.1mm Outside Dia. : 0.9mm max. Gas: Butane gas Purity 95% min. 

※ "room condition" temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

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<table>
<tr><th>No</th><th colspan="2">Items</th><th>Specification</th><th>Testing method</th></tr>
<tr><td rowspan="4">13</td><td rowspan="4">Life</td><td>Appearance</td><td>No marked defect.</td><td rowspan="4">Impulse Voltage
Each individual capacitor shall be subjected to 8kV impulses for three times. After the capacitors are applied to life test.
The waveform will be determined by the test circuit parameters. Details of the test circuit are given in IEC 60384-14 Annex A.


Front time (T1) =1.2μs=1.67T
Time to half-value (T2) =50μs
The specimen capacitors are placed in a circulating air oven for a period of 1000 hours. The air in the oven is maintained at a temperature of 125±3℃. Throughout the test, the capacitors are subjected to an AC850Vrms. alternating voltage of mains frequency.
Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>Capacitance Change</td><td>B(Y5P),E(Y5U),F(Y5V)：
Within ±20%
SL：Within±3% or ±0.3pF,
Whichever is large.</td></tr>
<tr><td>I.R.</td><td>B(Y5P),E(Y5U),F(Y5V)：
3000MΩ min.
SL： 1000MΩ min.</td></tr>
<tr><td>Dielectric Strength</td><td>Per Item 3</td></tr>
<tr><td>14</td><td colspan="2">Active Flammability</td><td>The cheesecloth shall not be on fire.</td><td>The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge.


C1,2：1uF±10% C3：0.033uF±5% 10KV
L1-4：1.5mH±20% 16A Rod core choke
R ：100Ω±2% Ct：3uF±5% 10KV
Uac：Ur±5% Ur：Rated working voltage
Cx ：Capacitor F ：Fuse, Rated 10A
Ut ：Voltage applied to Ct

</td></tr>
</table>

※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

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<table>
<tr><th>No</th><th colspan="2">Items</th><th>Specification</th><th>Testing method</th></tr>
<tr><td rowspan="4">15</td><td rowspan="4">Humidity (Under Steady State)</td><td>Appearance</td><td>No marked defect</td><td rowspan="4">Set the capacitor for 500±12 hours at 40±2℃, in 90 to 95% humidity.

Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>Capacitance Change</td><td>B(Y5P)： Within ±10%
E(Y5U)： Within ±20%
F(Y5V)： Within ±30%
SL：Within±2.5% or ±0.25pF,
Whichever is large.</td></tr>
<tr><td>D.F. or Q</td><td><table><tr><th>Char.</th><th>Specifications</th></tr><tr><td>B(Y5P)
E(Y5U)</td><td>5.0% max.</td></tr><tr><td>F(Y5V)</td><td>7.5% max.</td></tr><tr><td>SL</td><td>Q≧100+10×C/3※2(C<30pF)
Q≧ 200 (C≧30pF)</td></tr></table></td></tr>
<tr><td>I.R.</td><td>B(Y5P),E(Y5U),F(Y5V)：3000MΩ min.
SL： 1000MΩ min.</td></tr>
<tr><td rowspan="4">16</td><td rowspan="4">Humidity Loading</td><td>Appearance</td><td>No marked defect</td><td rowspan="4">Apply the rated voltage for 500±12 hours at 40±2℃, in 90 to 95% humidity.

Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>Capacitance Change</td><td>B(Y5P)： Within ±10%
E(Y5U)： Within ±20%
F(Y5V)： Within ±30%
SL：Within±2.5% or ±0.25pF,
Whichever is large.</td></tr>
<tr><td>D.F.
or
Q</td><td><table><tr><th>Char.</th><th>Specifications</th></tr><tr><td>B(Y5P)
E(Y5U)</td><td>5.0% max.</td></tr><tr><td>F(Y5V)</td><td>7.5% max.</td></tr><tr><td>SL</td><td>Q≧100+10×C/3
※2(C<30pF)
Q≧ 200 (C≧30pF)</td></tr></table></td></tr>
<tr><td>I.R.</td><td>B(Y5P),E(Y5U),F(Y5V)：3000MΩ min.
SL： 1000MΩ min.</td></tr>
<tr><td rowspan="4">17</td><td rowspan="4">Temperature Cycle</td><td>Appearance</td><td>No marked defect</td><td rowspan="4">The capacitor should be subjected to 100 temperature cycles,
<Temperature Cycle time: 100cycles>
<table><tr><th>Step</th><th>Temperature(℃)</th><th>Time(min)</th></tr><tr><td>1</td><td>-40+0/-3</td><td>30</td></tr><tr><td>2</td><td>Room temp.</td><td>3</td></tr><tr><td>3</td><td>125+3/-0</td><td>30</td></tr><tr><td>4</td><td>Room temp.</td><td>3</td></tr></table>
Pre-treatment: Capacitor shall be stored at 125±2℃ for 1hour.then placed at ※1room condition for 24±2hours before initial measurements.
Post-treatment: Capacitor shall be stored for 1 to 2hours at ※1room condition.</td></tr>
<tr><td>Capacitance Change</td><td><table><tr><th>Char.</th><th>Capacitance Change</th></tr><tr><td>B(Y5P)</td><td>Within ± 10%</td></tr><tr><td>E(Y5U)
F(Y5V)</td><td>Within ± 20%</td></tr><tr><td>SL</td><td>Within ± 10%</td></tr></table></td></tr>
<tr><td>D.F.
Q</td><td><table><tr><th>Char.</th><th>Specifications</th></tr><tr><td>B(Y5P)</td><td>5.0% max.</td></tr><tr><td>E(Y5U)
F(Y5V)</td><td>7.5% max.</td></tr><tr><td>SL</td><td>Q≧275+5/2C
※2(C<30pF)
Q≧350 (C≧30pF)</td></tr></table></td></tr>
<tr><td>I.R.</td><td>3000MΩ min.</td></tr>
<tr><td></td><td></td><td>Dielectric strength</td><td>Per Item .3</td><td></td></tr>
</table>

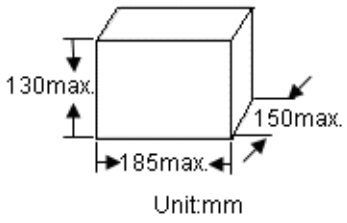
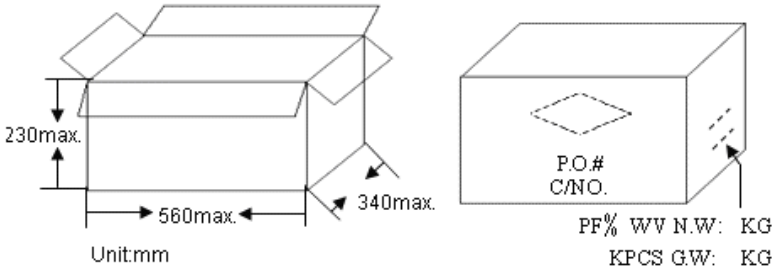
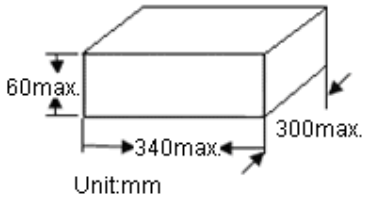
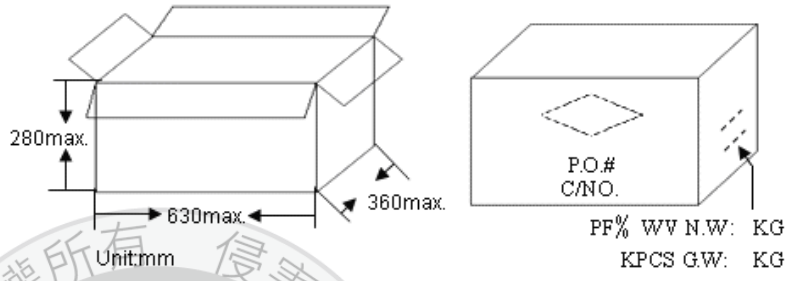
※ “room condition” temperature：15~35℃, humidity：45~75%,atmospheric pressure：86~106kPa

※ "C" expresses nominal capacitance value (pF).

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8.Packing Baggage：

8.1 Packing size:

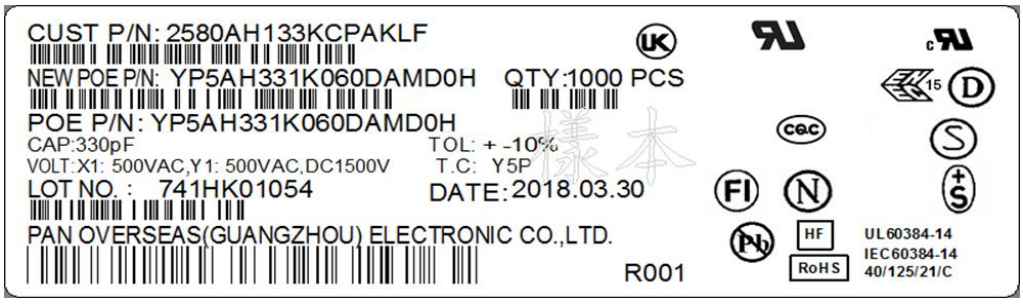
Type	Box	Carton
Bulk		
Ammo taping		

8.2 Packing quantity:

Packing type	The code of 14th to15th in SAP P/N	MPQ (Kpcs/Box)	Remark
Taping	AM (The size code≦11)	1	F=10mm (Code -17th"A" or "0")
	AM (The size code≧12)	0.5	
	AM(Code -17th"C")	0.5	F=12.5mm
	AS	1	
	AT	0.5	

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
Bulk	Long lead (L≧20mm)	06~12	0.5	1.5
		13	0.5	1
	Short lead (L＜20mm)	06~12	0.5	2
		13	0.5	1.5

8.3 Label samples



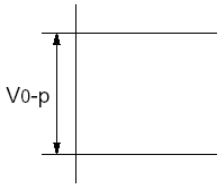
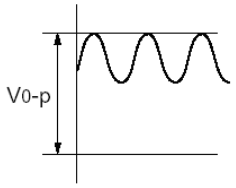
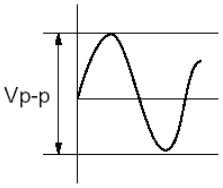
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9. Caution:

9.1 Operating voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage
Positional measurement			

9.2 Operating temperature and self-generated heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

9.3 Test condition for withstanding voltage

(1) Test equipment

Test equipment for AC withstanding voltage should be used with the performance of the wave similar to 50/60 Hz sine wave.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

(2) Voltage applied method

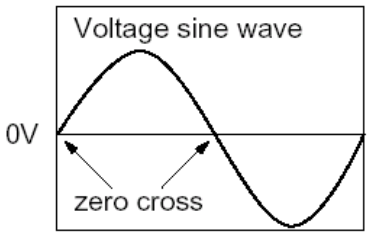
When the withstanding voltage is applied, capacitor's lead or terminal should be firmly connected to the out-put of the withstanding voltage test equipment, and then the voltage should be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage should be reduced to near zero, and then capacitor's lead or terminal should be taken off the out-put of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

*ZERO CROSS is the point where voltage sine wave pass 0V.

- See the right figure –



(3) Applied voltage

The voltages of Table shall be applied between the respective measuring points of 1 min for qualification approval and periodic testing and for a period of not less than 1 s for lot-by-lot quality conformance testing, a voltage proof test such as Test C shall be carried out only for qualification approval tests and periodic tests;

Attention is drawn to the fact that repetition of the voltage proof test by the user may damage the capacitor. If repetition of the voltage proof test is made by the user, the applied voltage should not be greater than 66 % of the test voltage specified in Table .

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Table –Voltage proof

Class	Range of rated voltages	Test A	Test B or Test C
X1	≤1 000 V	4,3 U_R (d.c.) c	2 U_R + 1 500 V (a.c.) with a minimum of 2 000 V (a.c.) a
Y1	≤500 V	4 000 V (a.c.)	4 000 V (a.c.)
a For Delta and T-connected capacitor units according to Figures 5b and 5c, the test voltage for terminals to case shall be the appropriate test voltage for the Y-capacitors. b The U_R in this d.c. test is the rated a.c.voltage value.			

Note:

Test A – Between terminations

Test B – Internal insulation

Test C – External insulation (applicable only to insulated capacitors in nonmetallic case or in insulated metal case)

Figure 5b – Delta by-pass capacitor (in metallic housing)

Figure 5c – Example of a T-connected by-pass capacitor (in non-metallic housing)

Figure 5b

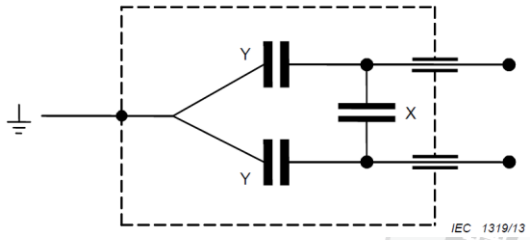
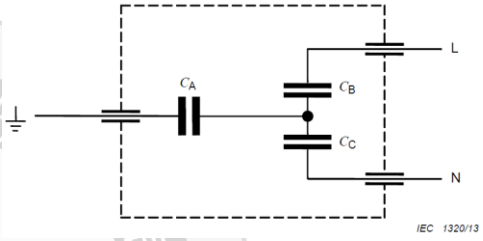


Figure 5c



*For capacitors with non-metallic housings, the earth connection is brought out as a separate termination as is shown in Figure 5c

9.4 Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

9.5 Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

9.6 Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification ofthe capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip : 400℃ max.

Soldering iron wattage : 50W max.

Soldering time : 3.5s max.

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9.7 Bonding, resin molding and coating

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

9.8 Treatment after bonding, resin molding and coating

When the outer coating is hot (over 100 ℃) after soldering, it becomes soft and fragile.

So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9.9 Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 ℃and 15 to 85%.

Use capacitors within 6 months after delivered. Check the solderability after 6 months or more.

9.10 Limitation of applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

1. Aircraft equipment
2. Aerospace equipment
3. Undersea equipment
4. Power plant control equipment
5. Medical equipment
6. Transportation equipment (vehicles, trains, ships, etc.)
7. Traffic signal equipment
8. Disaster prevention / crime prevention equipment
9. Data-processing equipment exerting influence on public
10. Application of similar complexity and/or reliability requirements to the applications listed in the above.

10. Notices:

10.1 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

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10.2 List of substances that affect the insulation strength of coating:

Epoxy resin solvent

Category	Model		
Ketone	Acetone	Butanone	Cyclohexanone
Esters	Ethyl acetate	Dibutyl phthalate	
Chlorinated hydrocarbons	Dichloromethane		

Epoxy resin thinner

Category		Model	
Reactive diluentactivated thinner	Simple function group	HK-66 (Alkyl glycidyl ether)	
		501 (Butyl glycidyl ether)	
		690 (Phenyl Glycidyl Ether)	
		AGE (C12-14Aliphatic Polyalcohol Glycidyl Ether)	
		692 (Benzyl Glycidyl Ether)	
	Two functional groups	D-678（Neopentyl glycol diglycidyl ether）	
		622 (1,4-Butanediol diglycidyl ether)	
		669 (Ethylene glycol diglycidyl ether)	
		X-632 (Polypropylene glycol diglycidyl ether)	
		X-652 (1,6-Hexadiol diglycidyl ether)	
		D-691Epoxypropane o-methylphenyl ether	
Non-activated thinner		Anhydrous ethanol	Toluene
		Ethyl acetate	Dimethylbenzene
		Dimethyl formamide	Butyl acetate
		Acetone	Styrene
		Polyol	Benzyl alcohol

Note: The above substances should not contact the coating of the product body, otherwise it will affect the insulation strength of the product

10.3 Capacitance change of capacitors

Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage.

Please contact us if you use for the strict time constant circuit.

Class 2 and 3 capacitors

Class 2 and 3 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

10.4 Performance check by equipment

Before using a capacitor, check that there is no problem in the equipment's performance and the specifications.

Generally speaking, CLASS 2 ceramic capacitors have voltage dependence characteristics and temperature dependence characteristics in capacitance. So, the capacitance value may change depending on the operating condition in a equipment. Therefore, be sure to confirm the apparatus performance of receiving influence in a capacitance value change of a capacitor, such as leakage current and noise suppression characteristic.

Moreover, check the surge-proof ability of a capacitor in the equipment, if needed, because the surge voltage may exceed specific value by the inductance of the circuit.

11. Note

11.1 Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

11.2 You are requested not to use our product deviating from this specification.

11.3 Do not use these products in any Automotive Power train or Safety equipment including Battery charger for Electric Vehicles and Plug-in Hybrid.

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12. Soldering Recommendation:

12.1 Wave Soldering Profile:

- Temperature conditions of the flow is recommended as shown in the chart
- Must implement the pre-heat
- Maximum peak flow temperature is recommended 265℃
- Time " T " implement in the chart recommended within 20 sec. it temperature exceed 200℃
- Take care with the flow solder not to touch the capacitor body directly at mounting

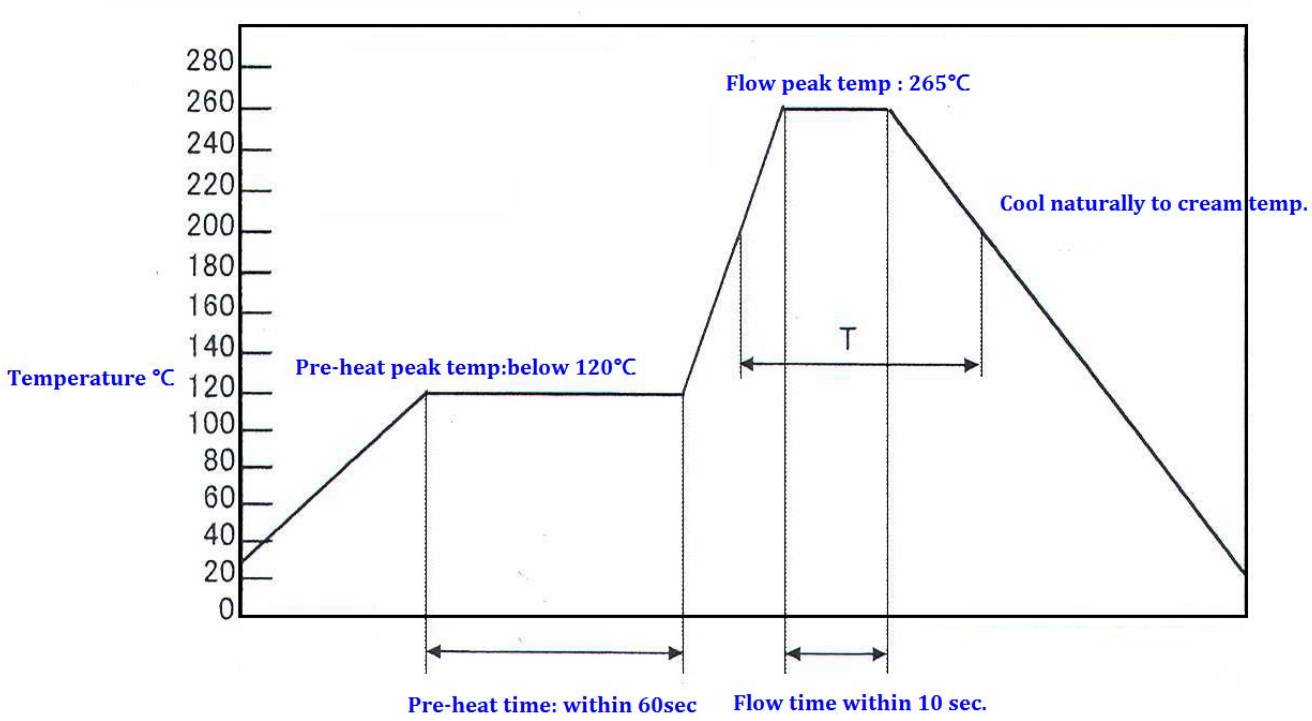


Chart to show flow recommended temp

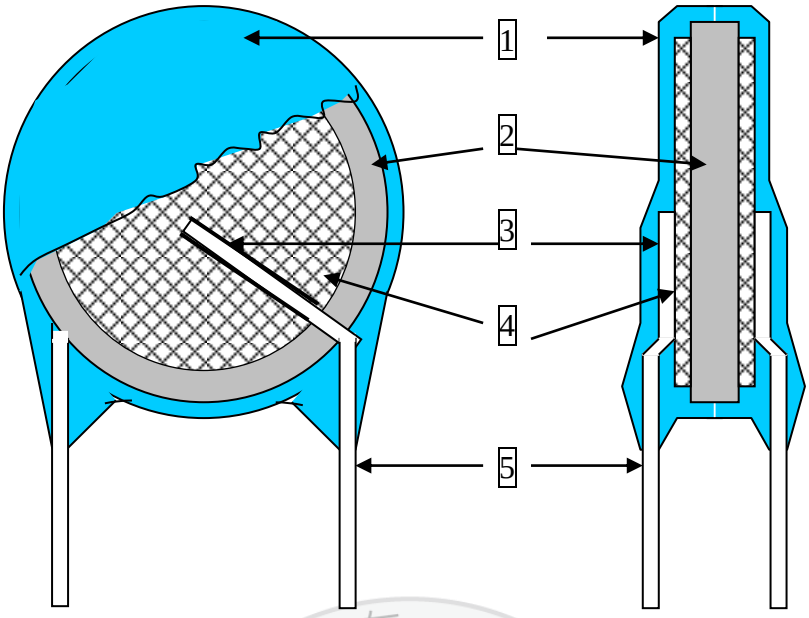
12.2 Recommended Reworking Conditions with Soldering Iron：

- Temperature of iron-tip: 400 degrees C. max.
- Soldering iron wattage: 50W max.
- Soldering time: 3.5 sec. max.
- Distance from coating body: 2 mm (min.)

12.3 Reflow-Soldering：Lead Ceramic Cap. should not be soldered by reflow-soldering.

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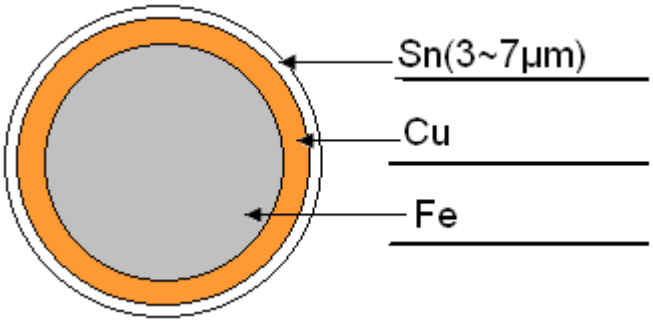
13. Drawing of internal structure and material list:



Remarks:

No.	Material	Description
1	Insulation Coating	Epoxy resins (Conforming to UL94V-0 standard) Type No.: confidential
2	Dielectric Element	Ceramic
3	Solder	Tin-Silver alloy
4	Electrodes	Silver [Ag]
5	Leads wire	Solder coated CP wire (Solder : Tin-Silver alloy)

***Constituent structure chart of lead**



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